Using the TPS40140EVM-003

User's Guide

Texas Instruments

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Using the TPS40140EVM-003 A 32-A Single Output Two-Phase Stackable Synchronous Buck Converter

The TPS40140EVM-003 evaluation module (EVM) is a single output two-phase synchronous buck converter. The EVM delivers 1.5 V at 32 A. The module uses the TPS40140 dual or 2-phase stackable synchronous buck controller. The EVM is also stackable with the other EVM to construct a multiphase converter.

1 Description

TPS40140EVM-003 is designed to use a regulated 10.8-V to 13.2-V bus to produce high-current regulated output. The TPS40140EVM-003 evaluation module demonstrates the TPS40140 in a typical regulated bus to low-voltage application while providing a number of test points to evaluate the performance of the TPS40140 in a given application.

1.1 Applications

- Graphics Cards
- Internet Servers
- Networking Equipment
- Telecommunications Equipment
- DC Power Distributed Systems

1.2 Features

- 10.8-V to 13.2-V Input Range
- 1.5-V Fixed Output
- 32-A_{DC} Steady State Current per Output
- 300-kHz Switching Frequency per Phase
- Single Main Switch N-channel MOSFET and Two Synchronous Rectifier N-channel MOSFETs per Phase
- Convenient Test Points for Probing Critical Waveforms and Non-Invasive Loop Response Testing

2 TPS40140EVM-003 Electrical Performance Specifications

Table 1. TPS40140EVM-003 Electrical and Performance Specifications

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Input Characteristics					
Input Voltage Range		10.8		13.2	V
Max Input Current	V_{IN} = 10.8 V, I_{OUT} = 32 A		4.98		A
No-Load Input Current	V_{IN} = 13.2 V, I_{OUT} = 0 A		130		mA
Output Characteristics (V_{OUT})					
Output Voltage			1.51		V
Output Voltage Regulation	Line Regulation (10.8 V <V_{IN} <13.2 V, I_{OUT} = 10 A)			0.1%	
	Load Regulation (0A <I_{OUT} <32 A, V_{IN} = 12 V)			0.5%	
Output Voltage Ripple	V_{IN} = 13.2 V, I_{OUT} = 32 A			40	mVpp
Output Load Current	I_{OUT}	0		32	A
Output Over Current			40		A
System Characteristics					
Switching Frequency			300		kHz
Peak Efficiency	V_{OUT} = 1.5 V, I_{OUT} = 20 A, V_{IN} = 10.8 V		91%		
Full Load Efficiency	V_{OUT} = 1.5 V, I_{OUT} = 32 A, V_{IN} = 12 V		89.9%		

3 Schematic

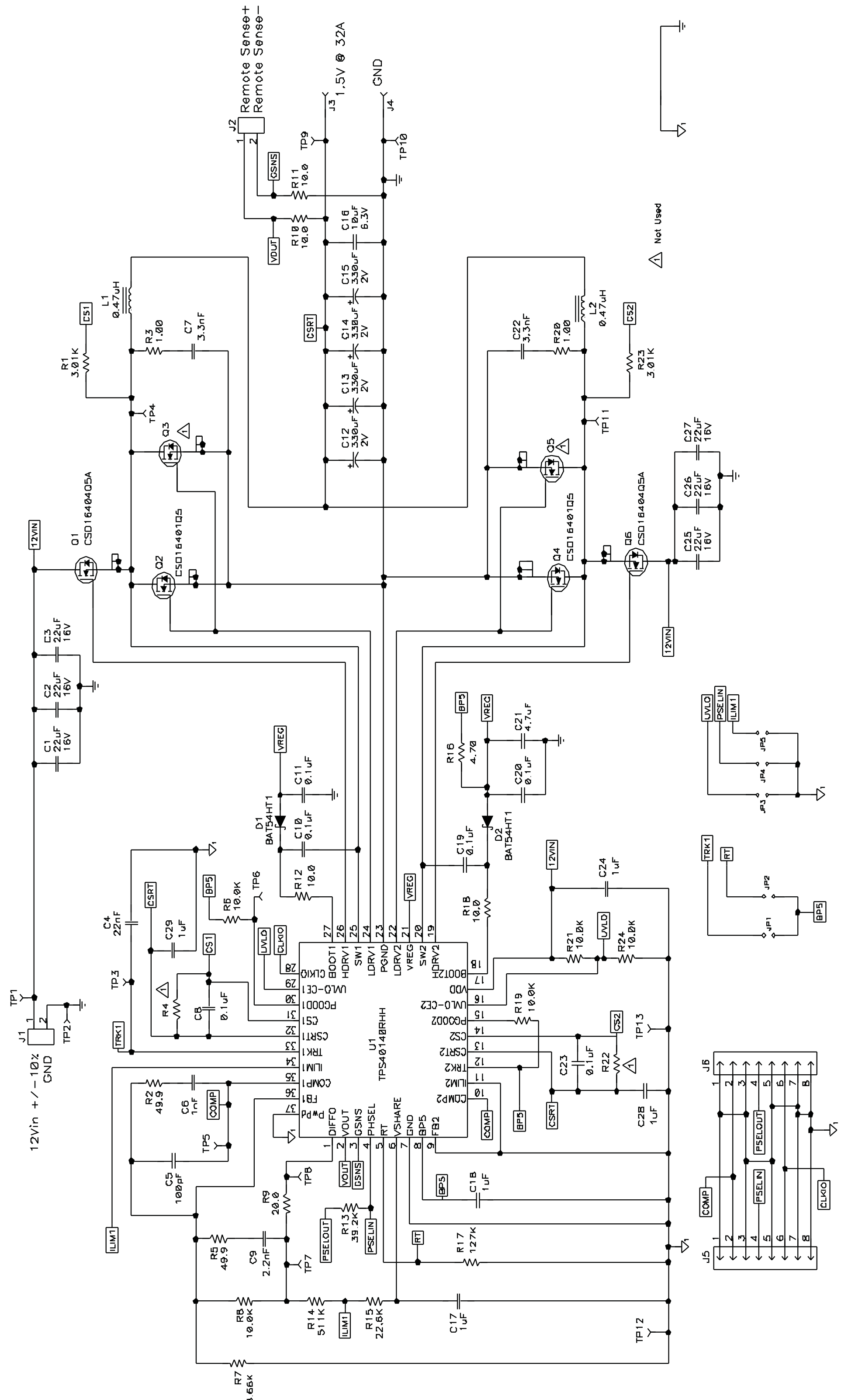

Figure 1. TPS40140EVM-003 Schematic (for reference only, see List of Materials for specific values)

4 Test Set Up

4.1 Recommended Test Equipment

4.1.1 Voltage Source

V_{IN}

The input voltage source (V_{IN}) should be a 0 V to 15V variable DC source capable of 10 A_{DC}. Connect VIN to J1 as shown in Figure 2.

4.1.2 Meters

V1: V_{IN}, 0 V to 15V voltmeter
V2: V_{OUT}, 0 V to 5V voltmeter
I1: 0 V to 10A current meter

4.1.3 Load

LOAD

The Output Load (LOAD) should be an Electronic Constant Current Mode Load capable of 0–40Adc at 1.5V

4.1.4 Oscilloscope

A Digital or Analog Oscilloscope can be used to measure the ripple voltage on V_{OUT}. The Oscilloscope should be set for 1MΩ impedance, 20MHz Bandwidth, AC coupling, 1µs/division horizontal resolution, 10mV/division vertical resolution for taking output ripple measurements. Test points TP9 and TP10 can be used to measure the output ripple voltage by placing the oscilloscope probe tip through TP9 and holding the ground barrel to TP10 as shown in Figure 3. Using a leaded ground connection may induce additional noise due to the large ground loop area.

4.1.5 Recommended Wire Gauge

V_{IN} to J1

The connection between the source voltage, V_{IN} and J1 of the EVM can carry as much as 6 Amps DC. The minimum recommended wire size is 1x AWG #16 per input connection, with the total length of wire less than 4 feet (2 feet input, 2 feet return).

J3, J4 to LOAD (Power)

The power connection between J3 and J4 of the EVM and LOAD can carry as much as 32Adc. The minimum recommended wire size is 2x AWG #14, with the total length of wire less than 4 feet (2 feet output, 2 feet return).

4.1.6 Other

FAN
This evaluation module includes components that can get hot to the touch, because this EVM is not enclosed to allow probing of circuit nodes, a small fan capable of 200-400 lfm is required to reduce component surface temperatures to prevent user injury. The EVM should not be left unattended while powered. The EVM should not be probed while the fan is not running.

4.2 Equipment Setup

Shown in Figure 2 is the basic test set up recommended to evaluate the TPS40140EVM-003.

Working at an ESD workstation, make sure that any wrist straps, bootstraps or mats are connected referencing the user to earth ground before power is applied to the EVM. Electrostatic smock and safety glasses should also be worn.

4.2.1 Input Connections

1. Prior to connecting the DC input source, V_{IN}, it is advisable to limit the source current from VIN to 6A maximum. Make sure V_{IN} is initially set to 0V and connected as shown in Figure 2.

4.2.2 Output Connections

1. Connect LOAD to J3 and J4, set LOAD to constant current mode to sink 0 Adc before V_{IN} is applied.
2. Connect voltmeter, V2, across TP9 and TP10, as shown in Figure 2.

4.2.3 Other Connections

1. Place Fan as shown in Figure 2 and turn on, making sure air is flowing across the EVM.

4.2.4 Set Up Diagram

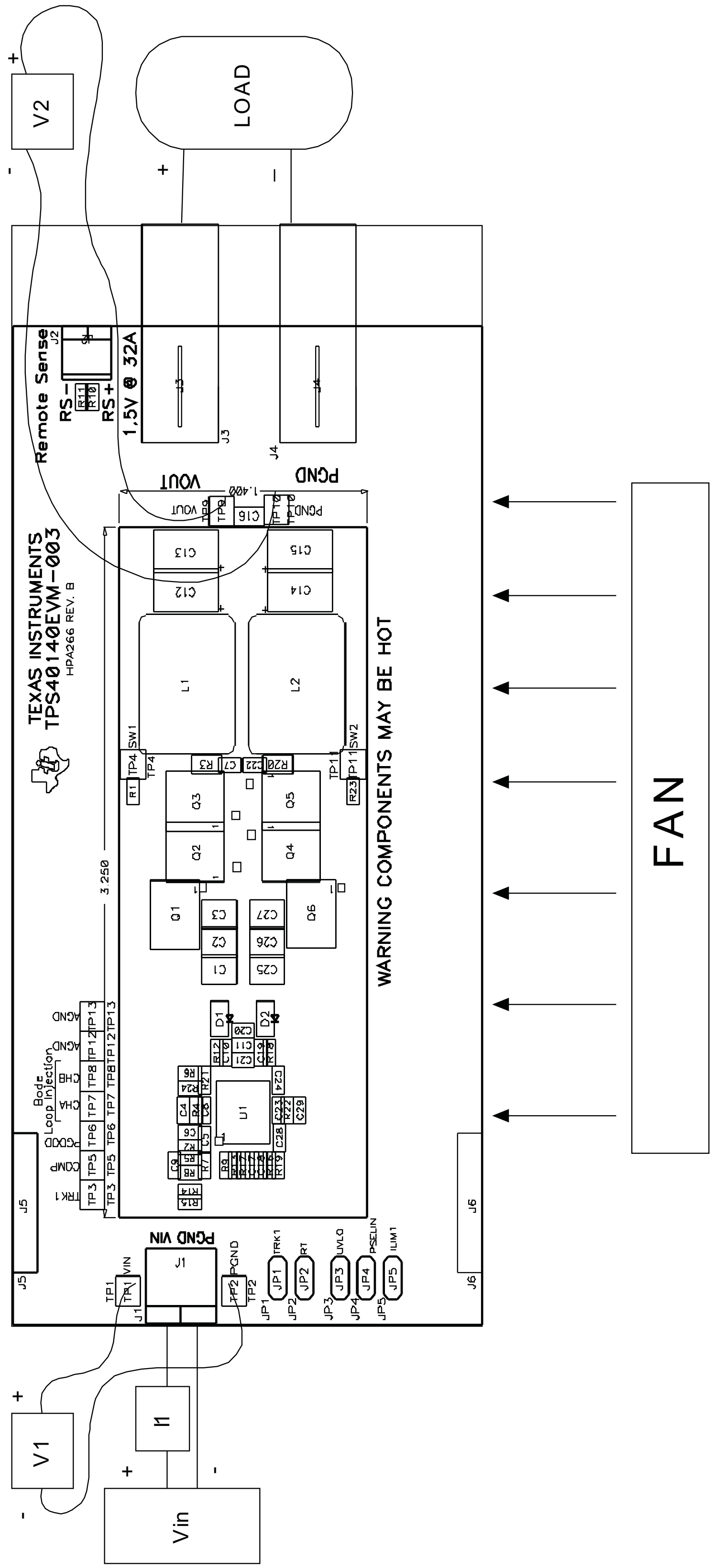

Figure 2. TPS40140EVM-003 Recommended Test Set-Up

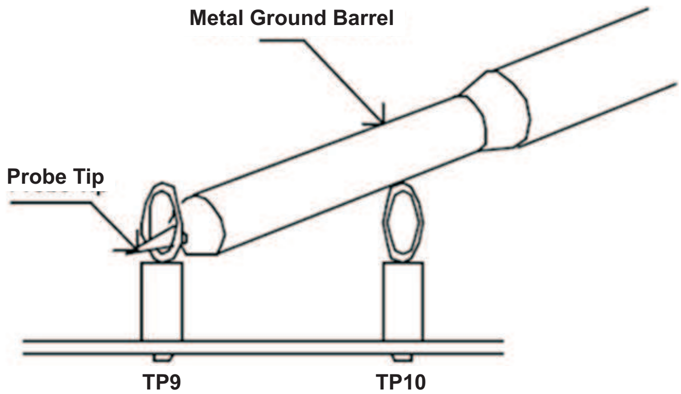

Figure 3. Output Ripple Measurement

4.3 Start Up and Test Procedure

1. Ensure LOAD is set to constant current mode and to sink 0 Adc.
2. Increase V_{IN} from 0 V to 10.8 Vdc, V_{OUT} should be in regulation per Table 1. Continue increasing V_{IN} to 12 V.
3. Vary LOAD from 0 to 32 Adc, V_{OUT} should remain in regulation per Table 1.
4. Vary V_{IN} from 10.8 Vdc to 13.2 Vdc, V_{OUT} should remain in regulation per Table 1.
5. For various V_{IN} settings vary LOAD from 0 to 32 Adc. V_{OUT} should remain in regulation per Table 1 for all combinations of load on LOAD up to 32 A.

4.4 Control Loop Gain and Phase Measurement Procedure

1. Connect 1 kHz–1 MHz Isolation Transformer to test points marked CHA and CHB.
2. Connect Input Signal Amplitude Measurement Probe (Channel A) to CHA.
3. Connect Output Signal Amplitude Measurement Probe (Channel B) to CHB.
4. Connect Ground Lead of Channel A and Channel B to AGND
5. Inject 25 mV or less signal through the Isolation Transformer.
6. Sweep Frequency from 100 Hz to 1 MHz with 10 Hz or lower post filter.
7. Control Loop Gain can be measured by $20 \times LOG\left(\frac{ChannelB}{ChannelA}\right)$
8. Control Loop Phase is measured by the Phase difference between Channel A and Channel B.
9. Disconnect Isolation Transformer from the bode plot test points before making other measurements (Signal Injection into Feedback may interfere with accuracy of other measurements).

4.5 EVM Configuration

4.5.1 Two Phase Single Output Configuration (Default)

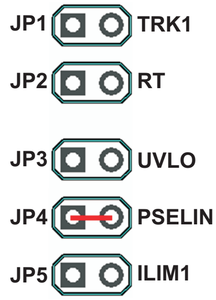

Figure 4. Default Configuration

JP4 is shorted with a jumper and others are left open. In this configuration, the EVM operates as a two phase single output converter.

4.5.2 Disabling the Output

JP3 allows the user to disable or enable the output. The output is disabled by shorting JP3 with a Jumper.

Figure 5. Output Disable Configuration

4.5.3 Multiphase Configuration

This EVM is stackable with other identical boards. For example, two EVMs can construct a fully interleaved four phase converter. In Figure 6, the EVM is configured as a master while stacking with the other EVM board.

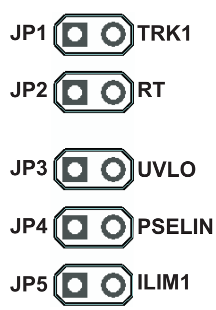

Figure 6. Configure the EVM as a Master for Stackable Operation

If two EVM boards are stacked together, the other EVM is configured as a slave as shown in Figure 7.

Figure 7. Configure the EVM as a Slave for Stackable Operation

If more than two EVM boards are stacked, for example three, the two slave EVMs have slightly different settings. Considering the master is the first board in the chain and all others are slaves, JP4 in the last slave board should be shorted by a jumper while it is left as open in other slave boards. The configurations are shown in Figure 8.

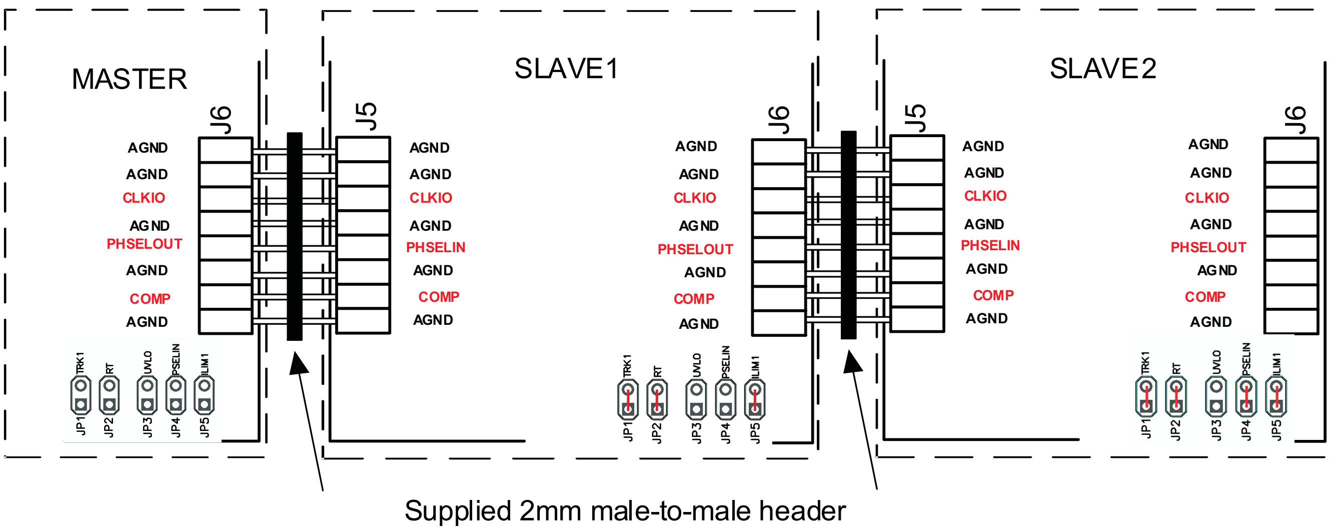

Figure 8. Master and Slave Connection (this EVM is the slave)

J5 and J6 are used to connect the EVM to the other EVM boards. Male-to-male headers are provided to make the connections between the boards.

4.6 Test Points

Several test points are located around the board. These can be used to sense what is occurring at different points of the converter. Table 2 lists these test points and what they are used for.

Table 2. List of Test Points

NAME	TEST POINT LABEL	DESCRIPTION
TP1	VIN	Input voltage positive sense point
TP2	PGND	Input voltage negative sense point
TP3	TRK1	Soft Start
TP4	SW1	Channel 1 switch node
TP5	COMP	Error amplifier output
TP6	PGOOD	Power Good
TP7	CHA	Loop injection point CHA
TP8	CHB	Loop injection point CHB
TP9	VOUT	Output positive sense point
TP10	PGND	Output negative sense point
TP11	SW2	Channel 2 switch node
TP12	AGND	Analog Ground
TP13	AGND	Analog Ground

4.7 Equipment Shutdown

1. Shut down LOAD
2. Shut down V_{IN}
3. Shut down FAN

5 TPS40140EVM-003 Typical Performance Data and Characteristic Curves

Figure 9 through Figure 13 present typical performance curves for the TPS40140EVM-003. Since actual performance data can be affected by measurement techniques and environmental variables, these curves are presented for reference and may differ from actual field measurements.

5.1 Efficiency and Power Loss

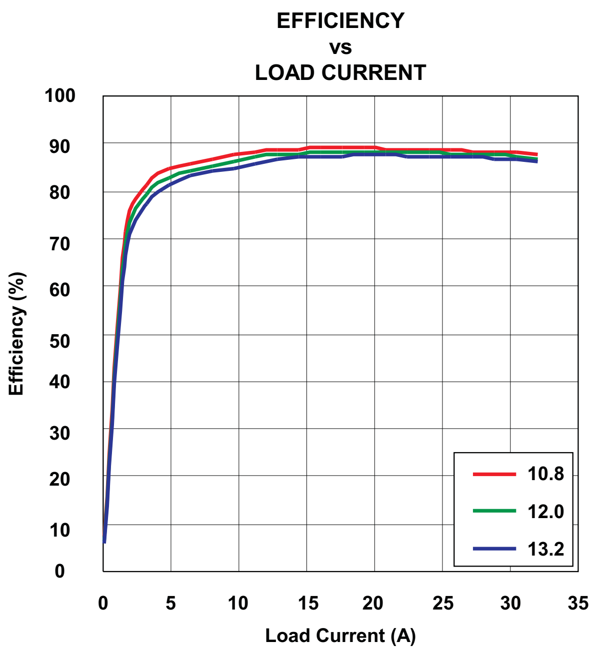

Figure 9. TPS40140EVM-003 Efficiency V_{IN} = 10.8–13.2 V, V_{OUT} = 1.5 V, I_{OUT} = 0–32 A

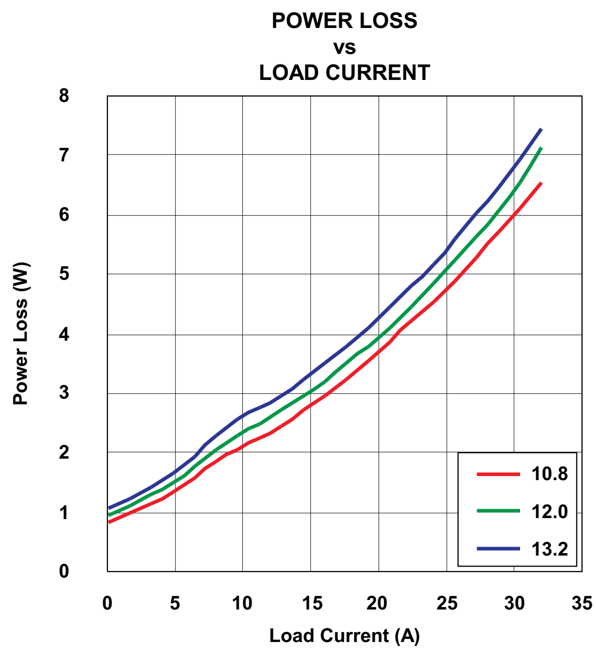

Figure 10. TPS40140EVM-003 V_{OUT} = 1.5-V Power Loss

5.2 Line and Load Regulation

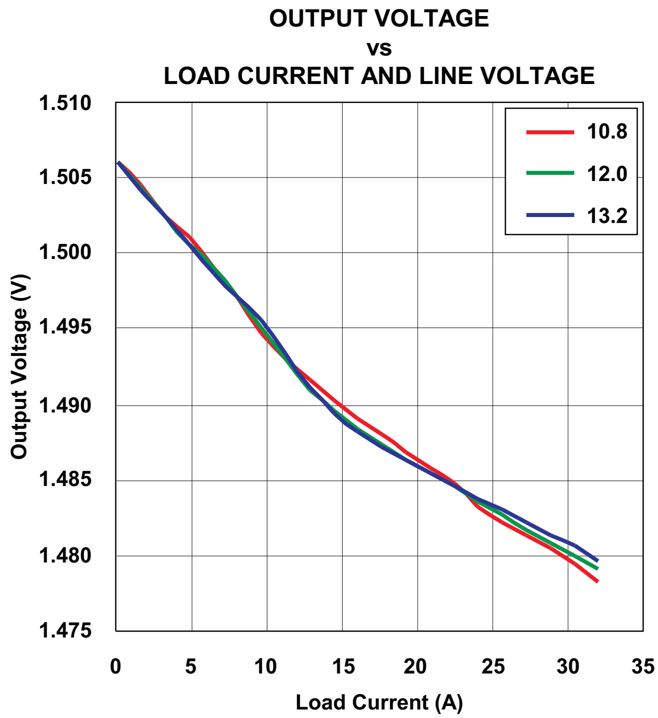

Figure 11. TPS40140EVM-003 V_{OUT} = 1.5-V Line and Load Regulation

5.3 Bode Plot

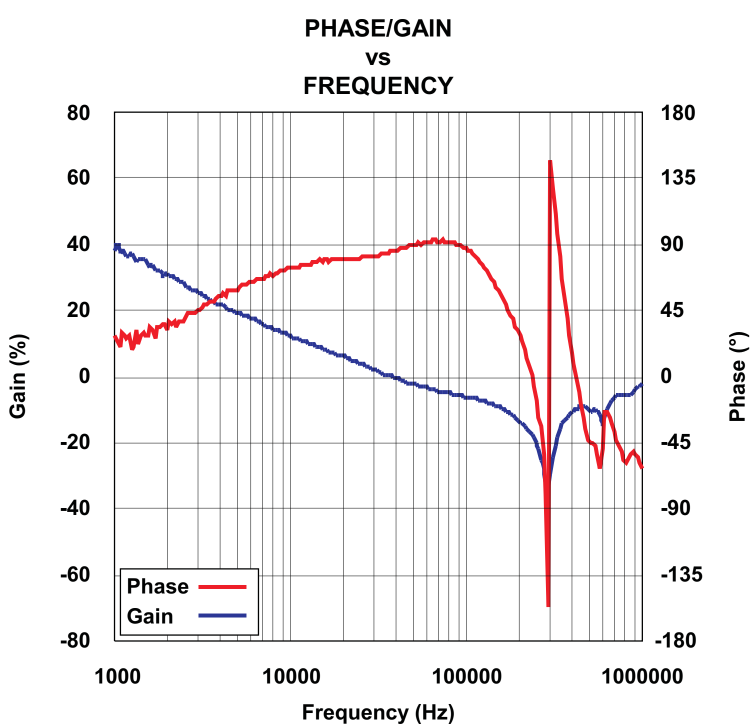

Figure 12. TPS40140EVM-003 Loop Gain, BW = 25 kHz, Phase Margin = 82°

5.4 Transient Response

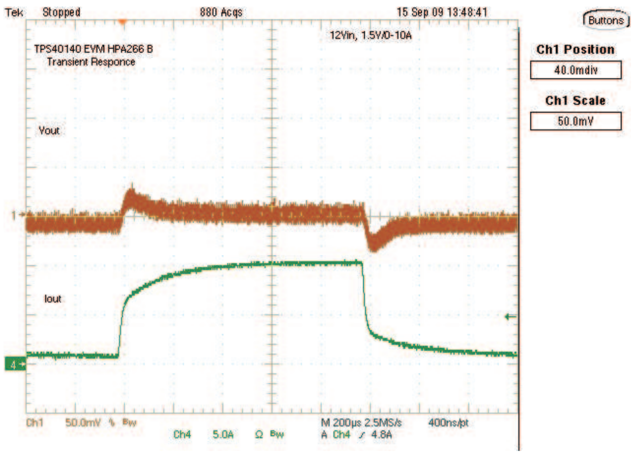

Figure 13. Transient Response 10 A Step, 2.5 A/µs, 50 mV/div Ch1: V_{OUT}; Ch4: I_{OUT}

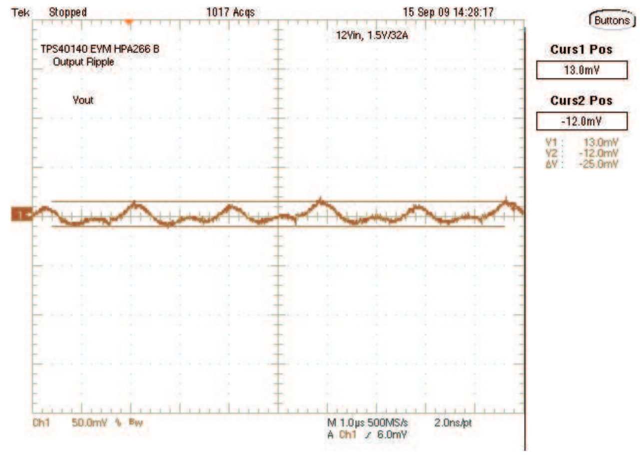

Figure 14. Ouput Ripple

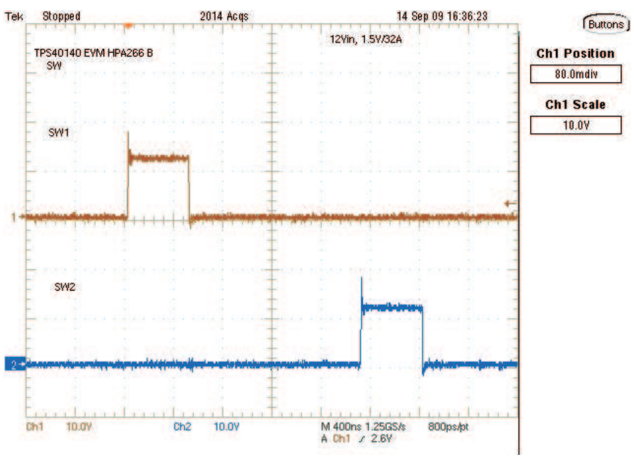

Figure 15. SW Node

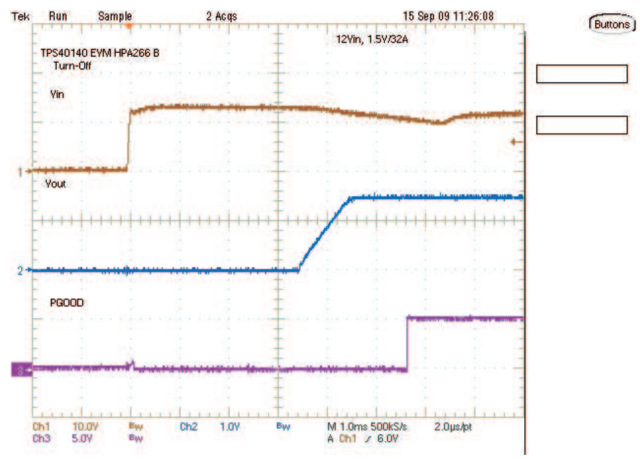

Figure 16. Turn ON

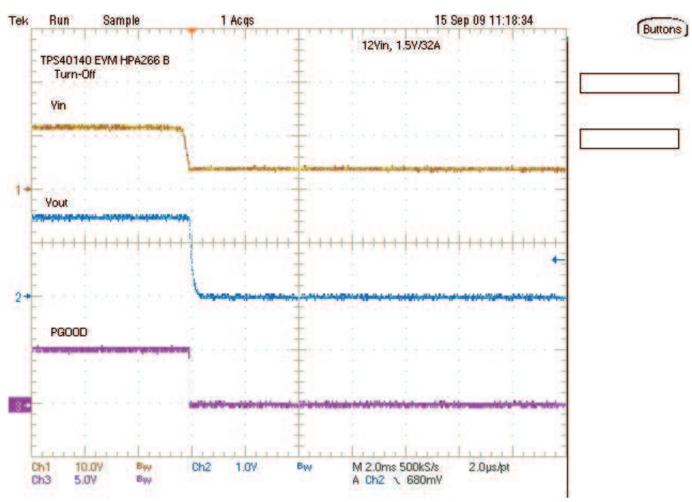

Figure 17. Turn OFF

6 EVM Assembly Drawings and Layout

Figure 18 through Figure 22 show the design of the TPS40140EVM-003 printed circuit board. The EVM has been designed using a four layer, 2 oz copper-clad circuit board with all components on the top side to allow the user to easily view, probe and evaluate the TPS40140 control IC in a practical application. Moving components to both sides of the PCB or using additional internal layers can offer additional size reduction for space constrained systems.

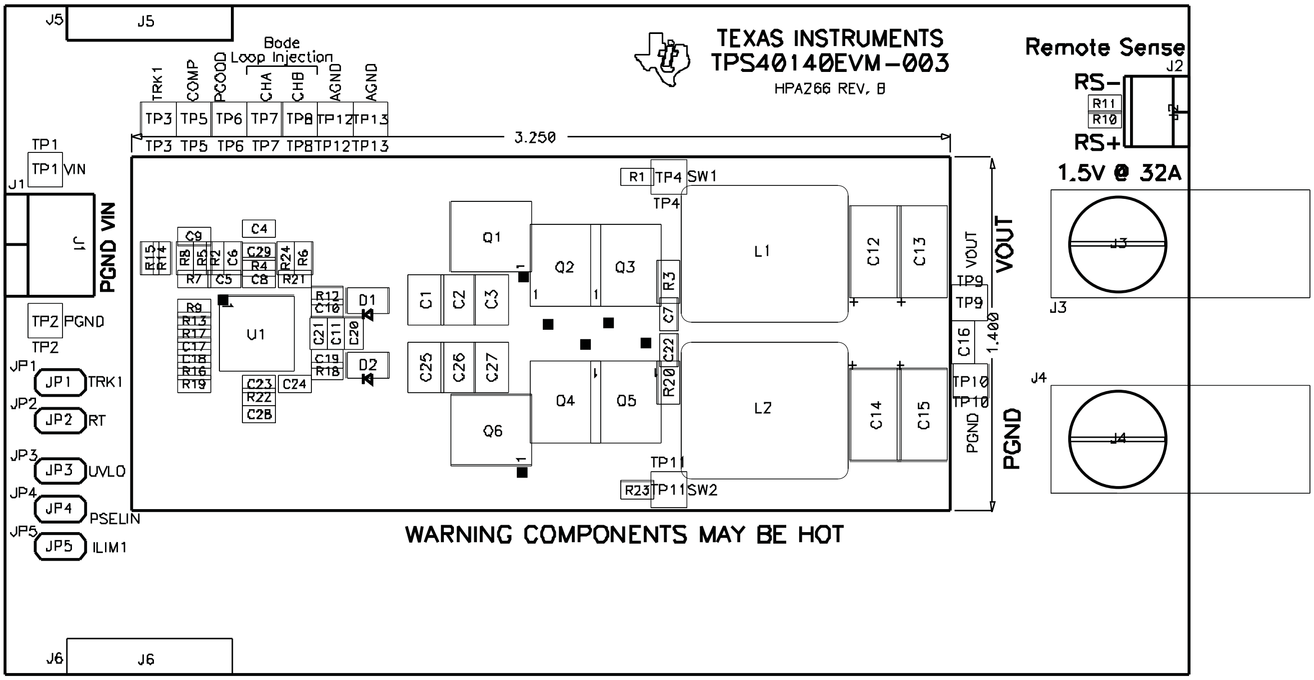

Figure 18. TPS40140EVM-003 Component Placement (Viewed from Top)

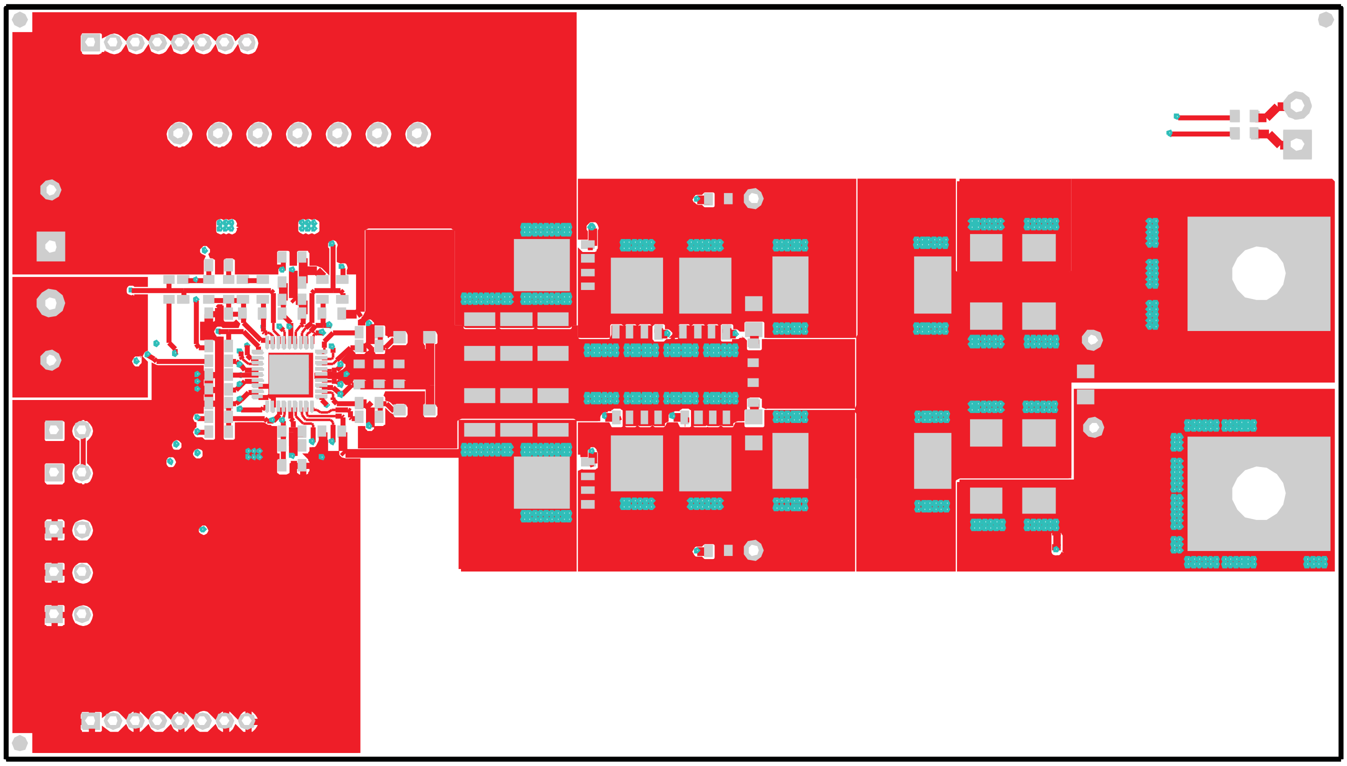

Figure 19. TPS40140EVM-003 Top Copper (Viewed from Top)

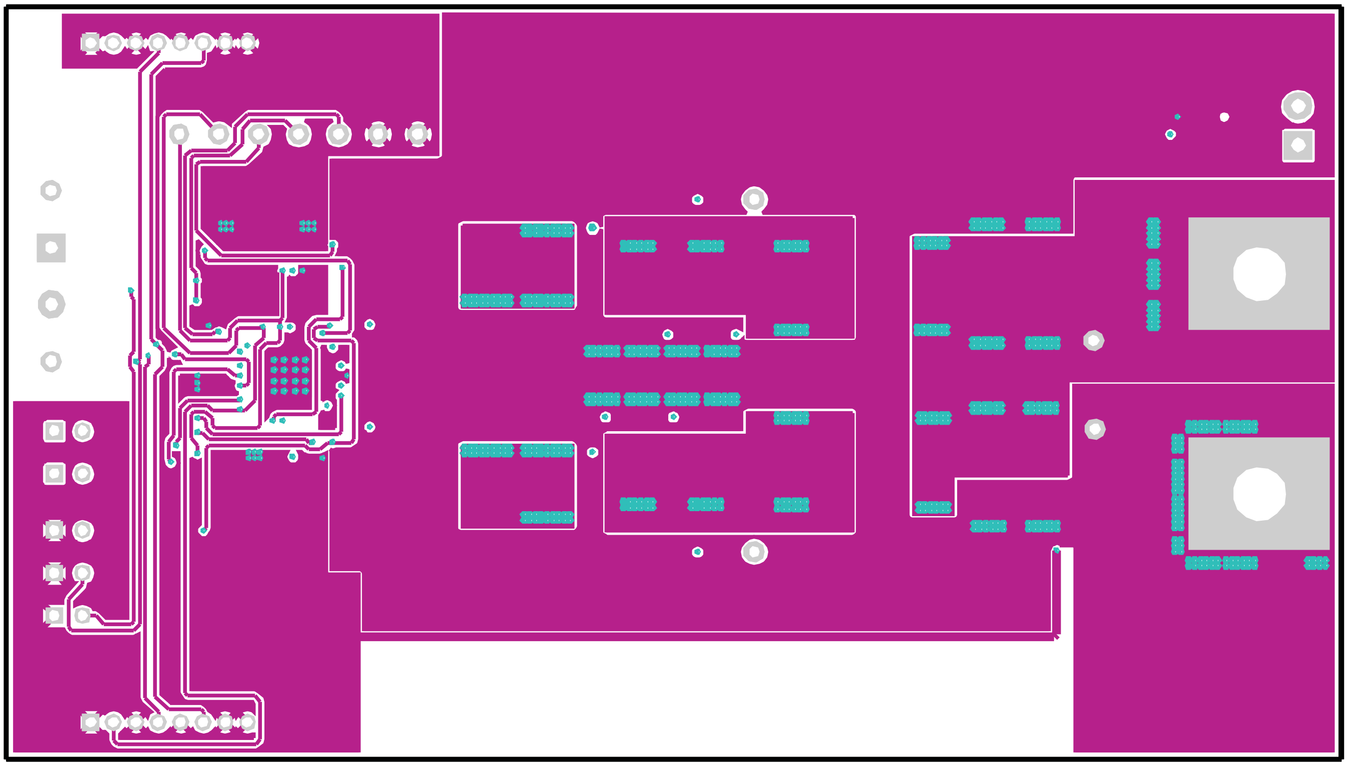

Figure 20. TPS40140EVM-003 Layer 2 Copper (X-Ray View from Top)

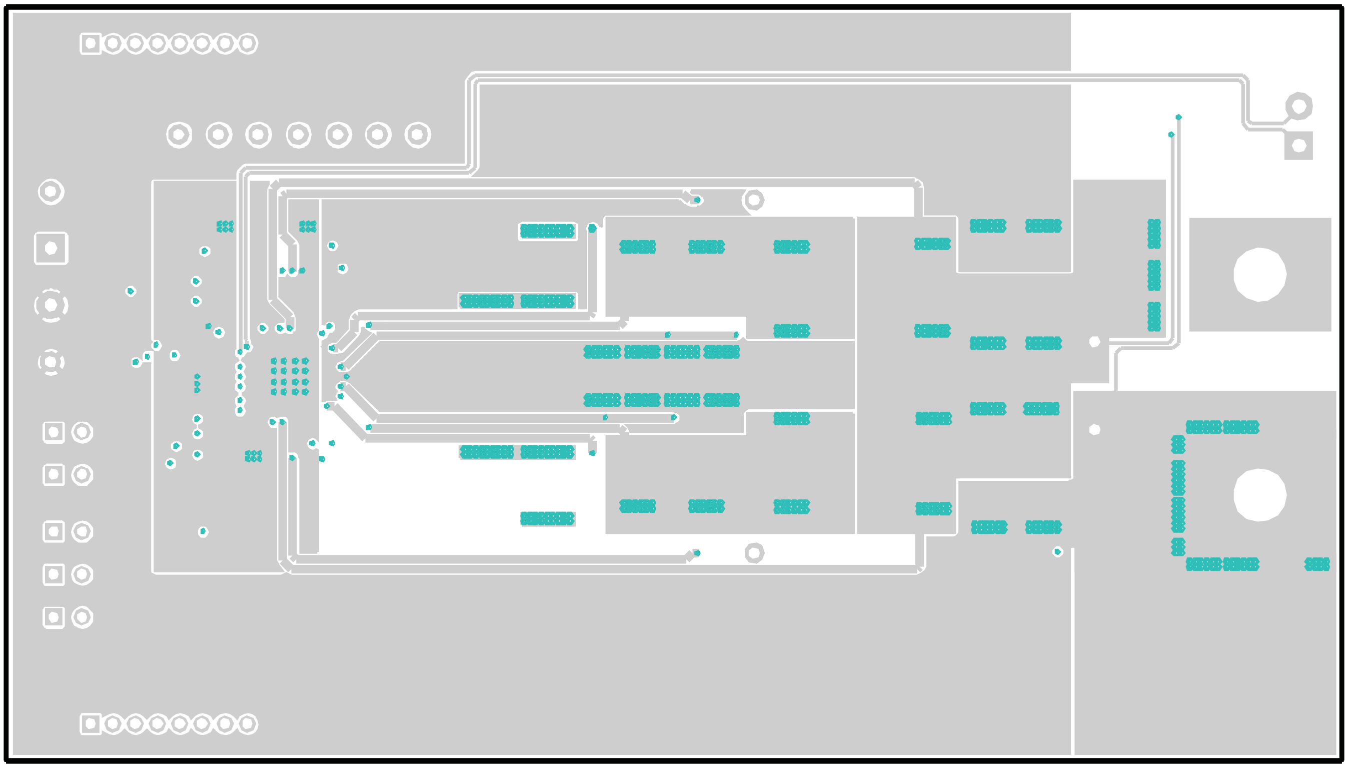

Figure 21. TPS40140EVM-003 Layer 3 Copper (X-Ray View from Top)

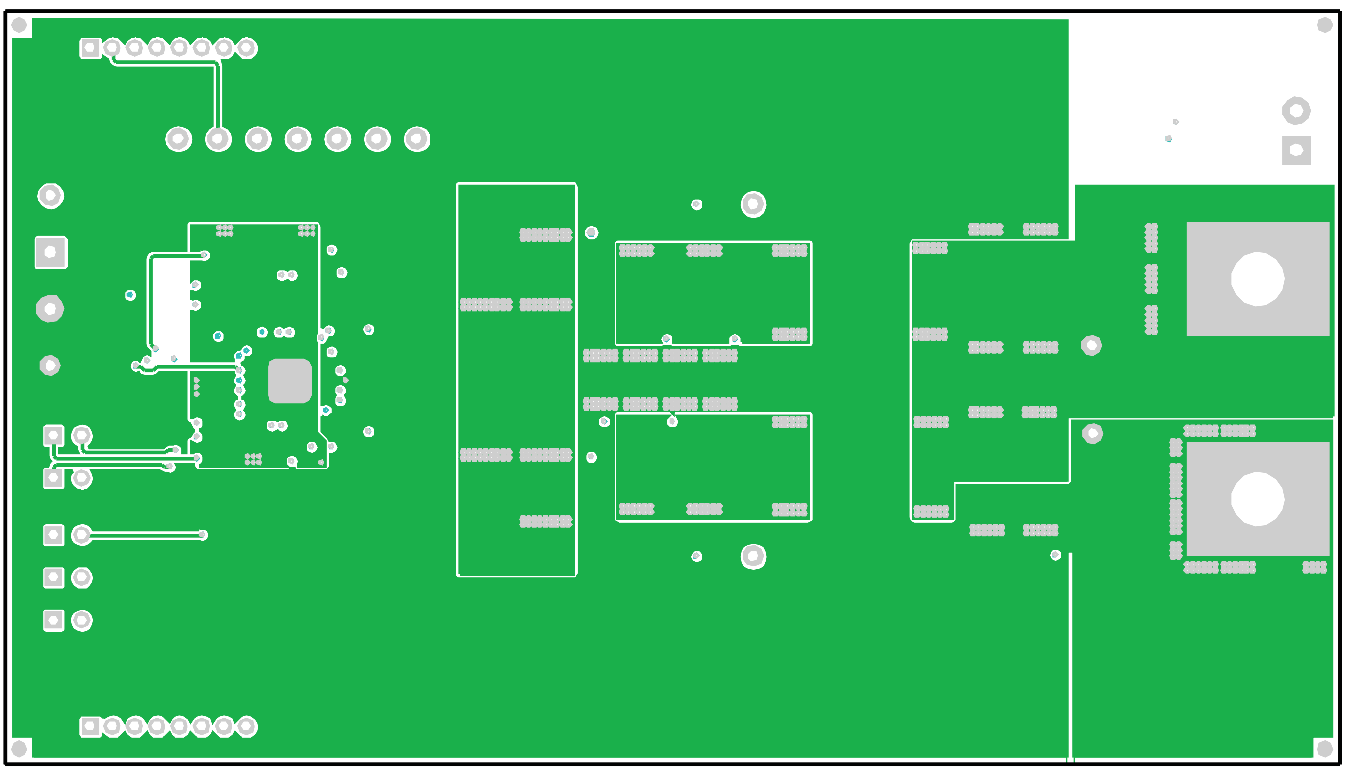

Figure 22. TPS40140EVM-003 Bottom Copper (X-Ray View from Top)

7 List of Materials

Table 3 lists the EVM components as configured according to the schematic shown in Figure 1.

Table 3. TPS40140EVM-003 List of Materials

COUNT	REFDES	DESCRIPTION	PART NUMBER	MFR
6	C1–C3, C25–C27	Capacitor, ceramic, 16 V, X5R, 20%, 22 μF	Std	Std
4	C12–C15	Capacitor, SP cap, 2 V, 0.006 Ω, 20%, 330 μF, 7343	EEFSX0D331XE	Panasonic
1	C16	Capacitor, ceramic, 6.3 V, X5R, 10%, 10 μF, 805	Std	Std
5	C17, C18, C24, C28, C29	Capacitor, ceramic, 16 V, X5R, 10%, 1 μF, 603	Std	Std
1	C21	Capacitor, ceramic, 6.3 V, X5R, 10%, 4.7 μF, 603	Std	Std
1	C4	Capacitor, ceramic, 16 V, X7R, 10%, 22 nF, 603	Std	Std
1	C5	Capacitor, ceramic, 16 V, X7R, 10%, 100 pF, 603	Std	Std
1	C6	Capacitor, ceramic, 16 V, X7R, 10%, 1000 pF, 603	Std	Std
2	C7, C22	Capacitor, ceramic, 16 V, X7R, 10%, 3.3 nF, 603	Std	Std
6	C8, C10, C11, C19, C20, C23	Capacitor, ceramic, 16 V, X7R, 10%, 0.1 μF, 603	Std	Std
1	C9	Capacitor, ceramic, 16 V, X7R, 10%, 2.2 nF, 603	Std	Std
2	D1, D2	Diode, Schottky, 30 V, 0.35 Vf, SOD323	BAT54HT1	On Semi
2	L1, L2	Inductor, SMT, 41 A, 0.001Ω, 0.47 μH, 0.512 × 0.571 in	IHLP-5050FD-0R47-M01	Vishay
2	Q1, Q6	MOSFET, N-channel, 25 V, 21A, 0.0041 Ω	CSD16404Q5A	TI
2	Q2, Q4	MOSFET, N-channel, 25 V, 38A, 0.0018 Ω	CSD16401Q5	TI
0	Q3, Q5	MOSFET, N-channel, 25 V, 38A, 0.0018 Ω	CSD16401Q5	TI
2	R1, R23	Resistor, chip, 1/16 W, 1%, 3.01 kΩ, 603	Std	Std
4	R10–R12, R18	Resistor, chip, 1/16 W, 1%, 10.0 Ω, 603	Std	Std
1	R16	Resistor, chip, 1/16 W, 1%, 4.70 Ω, 603	Std	Std
1	R14	Resistor, chip, 1/16 W, 1%, 511 kΩ, 603	Std	Std
1	R15	Resistor, chip, 1/16 W, 1%, 22.6 kΩ, 603	Std	Std
1	R17	Resistor, chip, 1/16 W, 1%, 127 kΩ, 603	Std	Std
1	R13	Resistor, chip, 1/16 W, 1%, 39.2 kΩ, 603	Std	Std
2	R3, R20	Resistor, chip, 1/8 W, 1%, 1.00 Ω, 805	Std	Std
1	R9	Resistor, chip, 1/16 W, 1%, 20.0 Ω, 603	Std	Std
0	R4, R22	Resistor, chip, 1/16 W, 1%, OPEN, 603	Std	Std
2	R2,R5	Resistor, chip, 1/16 W, 1%, 49.9 Ω, 603	Std	Std
5	R6, R8, R19, R21, R24	Resistor, chip, 1/16 W, 1%, 10.0 kΩ, 603	Std	Std
1	R7	Resistor, chip, 1/16 W, 1%, 8.66 kΩ, 603	Std	Std
1	U1	2-Phase or Dual Output PWM Controller, QFN-36	TPS40140RHH	Texas Instruments

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 10.8 V to 13.2 V and the output voltage range of 1.5 V at 0–32 A.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 85 °C. The EVM is designed to operate properly with certain components above 85 °C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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